## PATENT ASSIGNMENT COVER SHEET

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## PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14089112	

**PATENT** 

REEL: 031671 FRAME: 0213

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> PATENT REEL: 031671 FRAME: 0214

#### **DECLARATION**

·		directed to the application attached hereto, or
filed on	• •	n Number
APPARATUS AND METHOD FOR	CHARGE CONTROL IN V	VIRELESS CHARGING SYSTEM
The above-identified application was m	ade or authorized to be mad	e by me.
I believe I am the original inventor or an application.	n original joint inventor of a c	laimed invention in the above-identified
I hereby acknowledge that any willful fa by fine or imprisonment of not more tha		eclaration is punishable under 18 USC 1001
I have reviewed and understand the co	ntents of the above-identified	application, including the claims.
<del>-</del>	d in 37 CFR 1.56, including f reen the filing date of the prio	rademark Office all information known to me or continuation-in-part applications, material or application and the national or PCT
	ASSIGNMENT	
For valuable consideration, I, as a below	w-named assignor, hereby a	ssign to:
Samsung Electronics Co., Ltd. 129, Samsung-ro, Yeongtong-o Suwon-si, Gyeonggi-do, 443-76 Republic of Korea		IUCF-HYU (Industry-University Cooperation Foundation Hanyang University) 17 Haengdang-dong, Seongdong-gu, Seoul 133-791 Republic of Korea
and its successors and assigns (collect	ively hereinafter called "the A	Assignee"), the entire right, title, and interest
_	•	e subject of the application identified in the
above declaration, which is United Stat	• •	CT International Application Number
filed or		·
	lication number and the filing	ed application to hereafter complete this date of the above-identified application when red in this Assignment.
models, and design registrations grante above-identified application, and the rig	ed for any of the inventions a tht to claim priority based on	all United States and foreign patents, utility nd improvements that are the subject of the the filing date of the above-identified Industrial Property, the Patent Cooperation

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Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

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